

Low-Power HDMI/DVI Transmitter

Preliminary Technical Data

ADV7520NK

FEATURES

General

Low-power HDMI[™]/DVI transmitter ideal for portable applications

CEC controller and buffer reduces system overhead. Compatible with HDMI v1.3, DVI v1.0, and HDCP 1.3 Single 1.8V power supply

Video/audio inputs accept logic level s from 1.8V to 3.3V **Digital video**

80 MHz operation supports all video resolutions from 480i to 1080i

Programmable two-way color space converter Supports RGB, YCbCr, DDR

Supports ITU656 based embedded syncs

Auto input video format timing detection (CEA-861D)

Digital audio

Supports standard S/PDIF for stereo LPCM or compressed audio up to 192 kHz

8-channel uncompressed LPCM I2S audio up to 192 kHz Special features for easy system design

On-chip MPU with I2C® master to perform HDCP operations and EDID reading operations 5 V tolerant I²C and HPD I/Os, no extra device needed

No audio master clock needed for supporting S/PDIF

On-chip MPU reports HDMI events through interrupts and registers

APPLICATIONS

Digital video cameras, **Digital still cameras** Personal media players **Cellular handsets DVD** players and recorders **Digital set-top boxes** A/V receivers **HDMI** repeater

GENERAL DESCRIPTION

The ADV7520NK is an 80 MHz, high definition multimedia interface (HDMI) v.1.3 transmitter. It supports HDTV formats up to 1080i and 720p, and computer graphic resolutions up to XGA (1024 x 768 @ 75 Hz). With the inclusion of HDCP (available in the BGA package only), the

Rev. PrA

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FUNCTIONAL BLOCK DIAGRAM

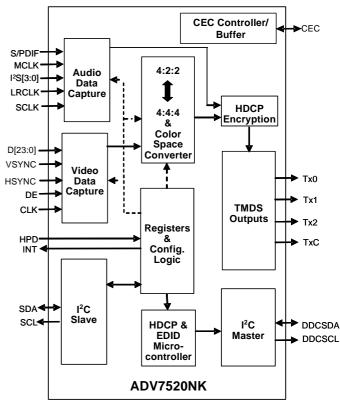


Figure 1.

ADV7520NK allows the secure transmission of protected content as specified by the HDCP v1.3 protocol.

The ADV7520NK supports both S/PDIF and 8-channel I2S audio. Its high fidelity 8-channel I²S can transmit either stereo or 7.1 surround audio at 192 kHz. The S/PDIF can carry stereo LPCM audio or compressed audio including Dolby® Digital and DTS®.

The ADV7520NK helps to reduce system design complexity and cost by incorporating such features as an internal MPU for HDCP operations, an I²C master for EDID reading, a single 1.8V power supply and 5 V tolerance on I²C and hot plug detect pins.

Fabricated in an advanced CMOS process, the ADV7520NK is available in a space saving, 76-ball, CSP_BGA or 64-lead LFCSP surface-mount package. Both packages are available as RoHS compliant and are specified from -25°C to +85°C operational.

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REVISION HISTORY

APPLICATIONS

DESIGN RESOURCES

Analog Devices, Inc. evaluation kits, reference design schematics, and other support documentation are available under NDA from flatpanel_apps@analog.com.

Other resources include:

EIA/CEA-861D that describes audio and video infoframes as well as the E-EDID structure for HDMI. It is available from Consumer Electronics Association (CEA).

The *HDMI v1.3*, a defining document for HDMI Version 1.3, and the *HDMI Compliance Test Specification Version 1.3* are available from HDMI Licensing, LLC.

The *HDCP v1.3* is the defining document for HDCP Version 1.3. available from Digital Content Protection, LLC.

ADV7520NK

OUTLINE DIMENSIONS

9.00 BSC SQ 1.00 PIN 1 INDICATOR 1.00 0.80 MAX 0.65 TYP 0.50 BSC 0.20 REF 64 LFCSP (LEAD FRAME CHIP SCALE PACKAGE) COMPLIANT TO JEDEC STANDARDS MO-220-VMMD EXCEPT FOR EXPOSED PAD COMPLIANT TO JEDEC STANDARDS MO-220-VMMD EXPOSED FOR EXPOSED PAD COMPLIANT TO JEDEC STANDARDS MO-220-VMMD EXPOSED FOR EXPOSED PAD COMPLIANT TO JEDEC STANDARDS MO-220-VMMD EXPOSED FOR EXPOSE

Figure 6. 64-pin LFCSP
Dimensions shown in millimeters

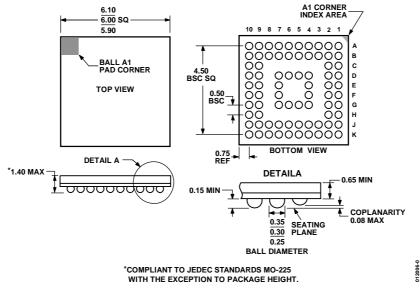


Figure 7. 76-Ball Chip Scale Package Ball Grid Array [CSP_BGA] 6 mm × 6 mm × 1.4 mm (BC-76) Dimensions shown in millimeters

ORDERING GUIDE

Model	Temp. Range	Package Description	Package Option
ADV7520NKBCPZ-80 ¹	−25°C to +85°C	64-pin Lead Formed Chip Scale Package	CP-64
ADV7520NKBBCZ-80	−25°C to +85°C	76-Ball Chip Scale Package Ball Grid Array [CSP_BGA]	BC-76
ADV7520NKBBCZRL-80	−25°C to +85°C	76-Ball Chip Scale Package Ball Grid Array [CSP_BGA]	BC-76
ADV7520NK/PCBZ		Evaluation Board	

¹ All packages are RoHS compliant

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NOTES